



# Material Composition Declaration

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This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.

**Adobe Reader version 7.0.5 is required to complete this declaration.**

1752-2 1.1	IPC Web Site for Information on IPC-1752 Standard <a href="http://www.ipc.org/IPC-175x">http://www.ipc.org/IPC-175x</a>	Form Type * Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informat
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## Supplier Information

Company Name * <b>ST MICROELECTRONICS</b>	Company Unique ID	Unique ID Authority	Response Date * N/A	Response Document ID				
Contact Name *	Title - Contact	Phone - Contact *	Email - Contact *					
Authorized Representative * <b>GIUSEPPE VITALI PALMA</b>	Title - Representative APM MD CHAMPION	Phone - Representative * N/A	Email - Representative * N/A	Supplier Comments or URL for Additional Information				
Requester Item Number	Mfr Item Number	Mfr Item Name	Effective Date	Version	Manufacturing Site	Weight *	UOM	Unit Type
	TL084IDT	DK7*0084BG6	2010-11-25	A	BO2A	136	mg	Each
Alternate Recommendation	PACKAGE: SO 14 .15 TO JEDE			Alternate Item Comments	ECOPACK2/ROHS; BSA: CD00277525			

## Manufacturing Process Information

Terminal Plating / Grid Array Material <b>Nickel/Palladium/Gold (Ni/Pd/Au)</b>	Terminal Base Alloy <b>CU Alloy</b>	J-STD-020 MSL Rating <b>1</b>	Peak Process Body Temperature <b>260 C</b>	Max Time at Peak Temperature <b>30 seconds</b>	Number of Reflow Cycles <b>3</b>
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Comments  
**DISCLAIMER: While STMicroelectronics has endeavored to provide information which is accurate and up to date, this document and its contents are provided on a strict "as is"**

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Import Data

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## RoHS Material Composition Declaration

Declaration Type \*

Simplified

RoHS Directive  
2002/95/EC

**RoHS Definition:** Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium

Supplier certifies that it gathered the information it provides in this form concerning RoHS restrictive substances using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form.

RoHS Declaration \*

1 - Item(s) does not contain RoHS restricted substances per the definition above

Supplier Acceptance \*

Accepted

**Exemptions:** If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.

## Declaration Signature

**Instructions:** Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

## Homogeneous Material Composition Declaration for Electronic Products

**SubItem Instructions:** The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

**Substance Instructions:** [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

**Line Functions:** +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

Item/SubItem Name	Homogeneous Material	Weight	Unit of Measure	Level	Substance Category	Substance	CAS	Exempt	Weight	Unit of Measure	Tolerance		PPM
											-	+	
IDK7*0084BG6	Silicon Die	2.363	mg	Supplier	Silicon die	Silicon	7440-21-3		2.362	mg			999,57
					die metallization	Aluminium(Al)	7429-90-5		0.001	mg			423
	Leadframe	36.262	mg	Supplier	alloy	Copper (Cu)	7440-50-8		35.337	mg			974,49
						Iron (Fe)	7439-89-6		0.851	mg			23,468
						Zinc (Zn)	7440-66-6		0.044	mg			1,214
						Iron Phosphide (FeP)	26508-33-8		0.03	mg			827
	Leadframe coating	0.243	mg	Supplier	coating	Nickel (Ni)	7440-02-0		0.223	mg	0		917,69
						Palladium (Pd)	7440-05-3		0.014	mg			57,614
						Gold (Au)	7440-57-5		0.006	mg			24,691
	Die Attach	0.99	mg	Supplier	glue	Silver (Ag)	7440-22-4		0.901	mg			910,10
					acrylate	Proprietary		0.049	mg			49,495	
					Methacrylate	Proprietary		0.04	mg			40,404	
Bonding wire	0.077	mg	Supplier	Bonding wire	Copper (Cu)	7440-50-8		0.077	mg			1,000,0	
Encapsulation	96.065	mg	Supplier	Moulding Compound	Epoxy Resin	Proprietary		7.205	mg			75,001	
					Phenol Resin	Proprietary		4.803	mg		49,998		
					Silica, vitreous	60676-86-0		83.193	mg		866,00		
					Carbon black	1333-86-4		0.48	mg		4,997		
					Bismuth (Bi)	7440-69-9		0.384	mg		3,997		